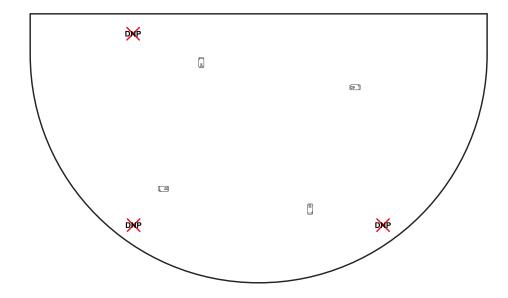
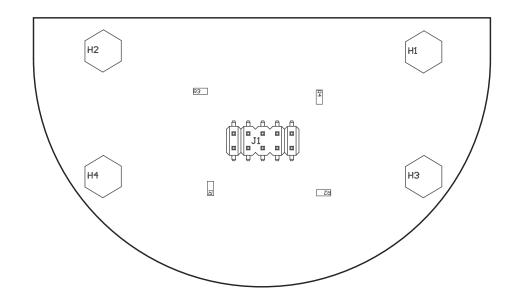
- ZZ1 Install label in silkscreened box after final wash. Text shall be 8 pt font. Text shall be per the Label Table in the PDF schematic.
- ZZZ These assemblies are ESD sensitive, ESD precautions shall be observed.
- ZZ3 These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.
- ZZ4 These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.



## COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

| PCB VIEWED FROM TOP SIDE         | BOARD #: TIDA-00464 | REV: E1       | SUN REV: | : Not In VersionControl |
|----------------------------------|---------------------|---------------|----------|-------------------------|
| TID #: TIDA-00464                |                     |               |          |                         |
| PLOT NAME = Top Assembly Drawing | GENERATED : 3/21/2  | 016 5: 35: 26 | PM       | TEXAS INSTRUMENTS       |



## COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

| PCB VIEWED FROM BOTTOM SIDE         | BOARD #: TIDA-00464 REV: E1 SVN REV: Not In VersionControl |  |  |  |
|-------------------------------------|--|--|--|--|
|                                     | TID #: TIDA-00464  |  |  |  |
| PLOT NAME = Bottom Assembly Drawing | GENERATED : 3/21/2016 5:35:27 PM TEXAS INSTRUMENTS         |  |  |  |

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